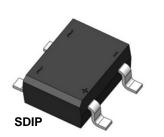
August 2010



# DF005S - DF10S Bridge Rectifiers

### Features

- Surge overload rating: 50 amperes peak.
- Glass passivated junction.
- Low leakage.
- UL certified, UL #E111753 and E326243.



### Absolute Maximum Ratings \* T<sub>A</sub> = 25°C unless otherwise noted

| Symbol             | Parameter   | Value       |     |     |     |     |     |      | Units |
|--------------------|---|-------------|-----|-----|-----|-----|-----|------|-------|
|                    |   | 005S        | 01S | 02S | 04S | 06S | 08S | 10S  | Units |
| V <sub>RRM</sub>   | Maximum Repetitive Reverse Voltage  | 50          | 100 | 200 | 400 | 600 | 800 | 1000 | V     |
| V <sub>RMS</sub>   | Maximum RMS Bridge Input Voltage  | 35          | 70  | 140 | 280 | 420 | 560 | 700  | V     |
| V <sub>R</sub>     | DC Reverse Voltage (Rated V <sub>R</sub> )  | 50          | 100 | 200 | 400 | 600 | 800 | 1000 | V     |
| I <sub>F(AV)</sub> | Average Recitified Forward Current<br>@ T <sub>A</sub> = 40°C   | 1.5         |     |     | А   |     |     |      |       |
| I <sub>FSM</sub>   | Non-Repetitive Peak Forward Surge Current         50           8.3ms Single Half-Sine-Wave         50 |             |     |     | А   |     |     |      |       |
| T <sub>STG</sub>   | Storage Temperature Range   | -55 to +150 |     | °C  |     |     |     |      |       |
| ТJ                 | Operating Junction Temperature  | -55 to +150 |     |     | °C  |     |     |      |       |

\* These ratings are limiting values above which the serviceability of any semiconductor device may by impaired.

### **Thermal Characteristics**

| Symbol           | Parameter  | Value | Units |
|------------------|--|-------|-------|
| P <sub>D</sub>   | Power Dissipation                                  | 3.1   | W     |
| R <sub>θJA</sub> | Thermal Resistance, Junction to Ambient, * per leg | 40    | °C/W  |

\* Device mounted on PCB with 0.5  $\times$  0.5" (13  $\times$  13mm).

## **Electrical Characteristics** $T_A = 25$ °C unless otherwise noted

| Symbol         | Parameter   | Value      | Units            |  |
|----------------|---|------------|------------------|--|
| V <sub>F</sub> | Forward Voltage, per element @ 1.0A   | 1.1        | V                |  |
| I <sub>R</sub> | Reverse Current, per element @ rated $V_R$<br>$T_A = 25^{\circ}C$<br>$T_A = 125^{\circ}C$ | 5.0<br>500 | μΑ<br>μΑ         |  |
|                | $I^{2}t$ Rating for Fusing t < 8.35ms   | 10         | A <sup>2</sup> s |  |
| CT             | Total Capacitance, per leg $V_R = 4.0V$ , f = 1.0MHz                                      | 25         | pF               |  |

### **Typical Performance Characteristics**

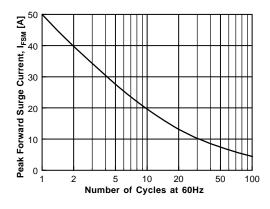


Figure 1. Non-Repetitive Surge Current

Figure 3. Forward Voltage Characteristics

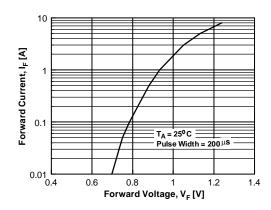


Figure 2. Forward Current Derating Curve

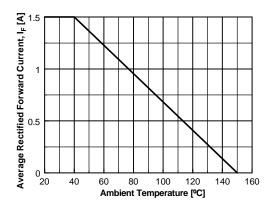
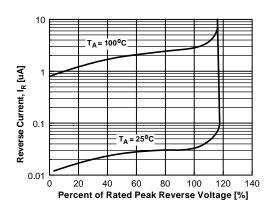


Figure 4. Reverse Current vs Reverse Voltage



### FAIRCHILD

#### SEMICONDUCTOR

#### TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

| AccuPower <sup>TM</sup><br>Auto-SPM <sup>TM</sup><br>Build it Now <sup>TM</sup><br>CorePLUS <sup>TM</sup><br>CorePOWER <sup>TM</sup><br>$CROSSVOLT^{TM}$<br>CTL <sup>TM</sup><br>CUrrent Transfer Logic <sup>TM</sup><br>DEUXPEED <sup>®</sup><br>Dual Cool <sup>TM</sup><br>EcoSPARK <sup>®</sup><br>EfficientMax <sup>TM</sup><br>ESBC <sup>TM</sup><br>$\mathbf{F}$<br><b>Fairchild</b> <sup>®</sup><br>Fairchild Semiconductor <sup>®</sup><br>FACT Quiet Series <sup>TM</sup><br>FACT <sup>®</sup><br>FastvCore <sup>TM</sup><br>FETBench <sup>TM</sup><br>FlashWriter <sup>®</sup> *<br>FPS <sup>TM</sup> | F-PFS™<br>FRFET®<br>Global Power Resource<br>Green FPS™<br>Green FPS™ e-Series™<br>GTO™<br>IntelliMAX™<br>ISOPLANAR™<br>MegaBuck™<br>MiCroPaLR™<br>MicroPak™<br>MiCroPak™<br>MicroPak™<br>MicroPak™<br>MicroPak™<br>MicroPak™<br>MicroPak™<br>Motion-SPM™<br>OptoHiT™<br>OPTOLOGIC®<br>OPTOPLANAR® | Power-SPM™<br>PowerTrench®<br>PowerXS™<br>Programmable Active Droop™<br>QFET®<br>QS™<br>Quiet Series™<br>RapidConfigure™<br>PowerXS™<br>Saving our world, 1mW/W/kW at a time™<br>SignalWise™<br>SmartMax™<br>SMART START™<br>SpM®<br>STEALTH™<br>SuperSOT™-3<br>SuperSOT™-6<br>SuperSOT™-6<br>SuperSOT™-8<br>SuperSOT™-8<br>SuperMOS®<br>SyncFET™<br>Sync-Lock™ | SYSTEM <sup>®*</sup> The Power Franchise         TinyBoost <sup>TM</sup> TinyBock <sup>TM</sup> TinyDock <sup>TM</sup> TinyDock <sup>TM</sup> TinyDock <sup>TM</sup> TinyPower <sup>TM</sup> UNPOWER <sup>TM</sup> UNPOWER <sup>TM</sup> TinyPOWer <sup>TM</sup> TinyPOWer <sup>TM</sup> TinyPOWer <sup>TM</sup> Ultra FRFET <sup>TM</sup> Ultra FRFET <sup>TM</sup> VOXT <sup>M</sup> VisualMax <sup>TM</sup> XS <sup>TM</sup> |
|---|--|---|---|
|---|--|---|---|

\* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

#### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

#### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

#### As used herein:

- Life support devices or systems are devices or systems which, (a) are
  intended for surgical implant into the body or (b) support or sustain life,
  and (c) whose failure to perform when properly used in accordance
  with instructions for use provided in the labeling, can be reasonably
  expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

#### ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

#### PRODUCT STATUS DEFINITIONS

| Product Status        | Definition  |  |  |
|-----------------------|---|--|--|
| Formative / In Design | Datasheet contains the design specifications for product development. Specifications may change in<br>any manner without notice.  |  |  |
| First Production      | Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design. |  |  |
| Full Production       | Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes<br>at any time without notice to improve the design.  |  |  |
| Not In Production     | Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor.<br>The datasheet is for reference information only.   |  |  |
|                       | Formative / In Design<br>First Production<br>Full Production  |  |  |